



Product Change Notification

Change Notification #: 116024 - 01

Change Title: Intel® Server System R1304JP4OC, PCN 116024-01, Label, Product Design, Update regulatory label to include India BIS mark implementation for PSU and change PSU product code, Reason for Revision: Updating Label and adding new PSU product code change description

Date of Publication: February 15, 2018

Key Characteristics of the Change:

Label, Product Design

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material: *	January 28, 2018
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* Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.

Description of Change to the Customer:

Reason for Revision: Updating Label and adding new PSU product code change description

Intel is implementing the following changes on the Intel Server System R1304JP4OC.

1. Update India BIS mark regulatory label implementation for PSU. Please see Figure-1 below for details.



Figure-1

2. Power Supply Unit model changed from DPS-500WB-1 A to DPS-500WB-2 C. The new model is identical in form factor and function than the previous one

Customer Impact of Change and Recommended Action:

In order for the system to recognize the new PSU model, customer needs to update the Field Replaceable Unit and Sensor Domain Record (FRUSDR) to version 1.07 or later.

Intel does not expect any impact to customers from these changes, but encourages customers to understand these changes and determine the impact on their applications.

Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change TA	Post Change TA
R1304JP4OC	923165	G76215-008	G76215-009

PCN Revision History:

Date of Revision:

January 12, 2018

February 15, 2018

Revision Number:

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01

Reason:

Originally Published PCN

Updating Label and adding new PSU product code change description



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116024 - 01

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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